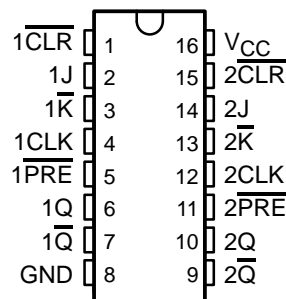


# CD54ACT109, CD74ACT109 DUAL J- $\bar{K}$ POSITIVE-EDGE-TRIGGERED FLIP-FLOPS WITH CLEAR AND PRESET

SCHS327 – JANUARY 2003

- Inputs Are TTL-Voltage Compatible
- Speed of Bipolar F, AS, and S, With Significantly Reduced Power Consumption
- Balanced Propagation Delays
- $\pm 24$ -mA Output Drive Current
  - Fanout to 15 F Devices
- SCR-Latchup-Resistant CMOS Process and Circuit Design
- Exceeds 2-kV ESD Protection Per MIL-STD-883, Method 3015

CD54ACT109 . . . F PACKAGE  
CD74ACT109 . . . E OR M PACKAGE  
(TOP VIEW)



## description/ordering information

The 'ACT109 devices contain two independent J- $\bar{K}$  positive-edge-triggered flip-flops. A low level at the preset ( $\overline{PRE}$ ) or clear ( $\overline{CLR}$ ) inputs sets or resets the outputs, regardless of the levels of the other inputs. When  $\overline{PRE}$  and  $\overline{CLR}$  are inactive (high), data at the J and  $\bar{K}$  inputs meeting the setup-time requirements are transferred to the outputs on the positive-going edge of the clock (CLK) pulse. Clock triggering occurs at a voltage level and is not directly related to the rise time of the clock pulse. Following the hold-time interval, data at the J and  $\bar{K}$  inputs can be changed without affecting the levels at the outputs. These versatile flip-flops can perform as toggle flip-flops by grounding  $\bar{K}$  and tying J high. They also can perform as D-type flip-flops if J and  $\bar{K}$  are tied together.

## ORDERING INFORMATION

| T <sub>A</sub> | PACKAGE† |               | ORDERABLE PART NUMBER | TOP-SIDE MARKING |
|----------------|----------|---------------|-----------------------|------------------|
| –55°C to 125°C | PDIP – E | Tube          | CD74ACT109E           | CD74ACT109E      |
|                | SOIC – M | Tube          | CD74ACT109M           | ACT109M          |
|                |          | Tape and reel | CD74ACT109M96         |                  |
|                | CDIP – F | Tube          | CD54ACT109F3A         | CD54ACT109F3A    |

† Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at [www.ti.com/sc/package](http://www.ti.com/sc/package).

FUNCTION TABLE  
(each flip-flop)

| INPUTS           |                  |     |   |           | OUTPUTS |            |
|------------------|------------------|-----|---|-----------|---------|------------|
| $\overline{PRE}$ | $\overline{CLR}$ | CLK | J | $\bar{K}$ | Q       | $\bar{Q}$  |
| L                | H                | X   | X | X         | H       | L          |
| H                | L                | X   | X | X         | L       | H          |
| L                | L                | X   | X | X         | H†      | H†         |
| H                | H                | ↑   | L | L         | L       | H          |
| H                | H                | ↑   | H | L         | Toggle  |            |
| H                | H                | ↑   | L | H         | Q0      | $\bar{Q}0$ |
| H                | H                | ↑   | H | H         | H       | L          |
| H                | H                | L   | X | X         | Q0      | $\bar{Q}0$ |

† Unpredictable and unstable condition if both  $\overline{PRE}$  and  $\overline{CLR}$  go high simultaneously after both being low at the same time



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PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

**TEXAS  
INSTRUMENTS**

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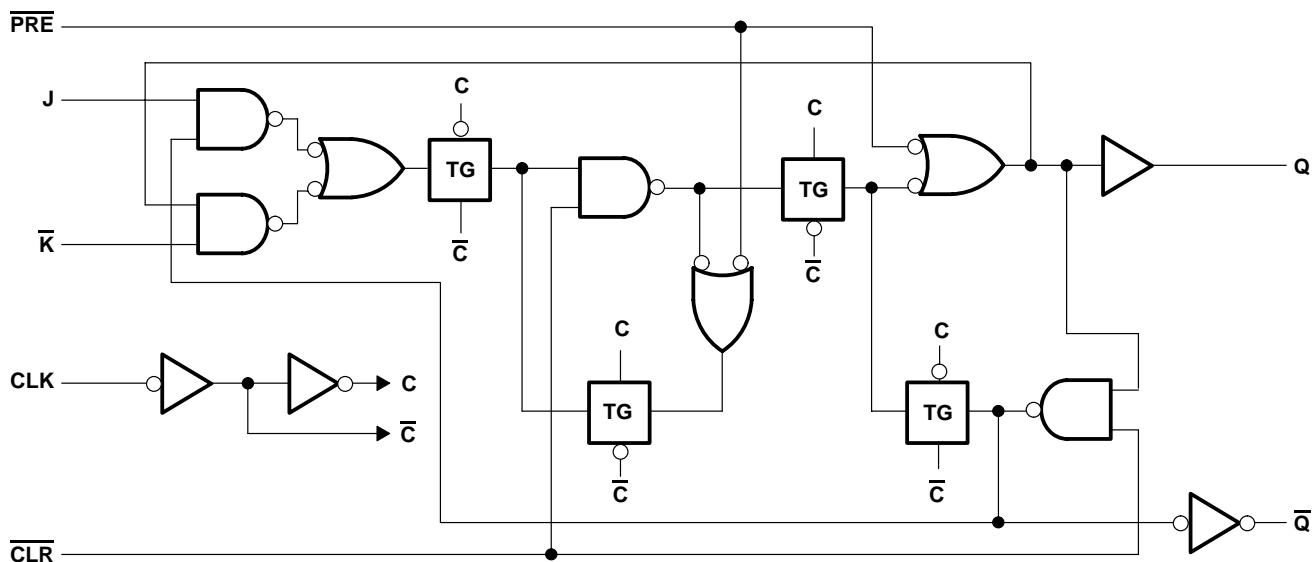
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# CD54ACT109, CD74ACT109

## DUAL J-K POSITIVE-EDGE-TRIGGERED FLIP-FLOPS WITH CLEAR AND PRESET

SCHS327 – JANUARY 2003

### logic diagram, each flip-flop (positive logic)



### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)<sup>†</sup>

|   |                |
|---|----------------|
| Supply voltage range, $V_{CC}$  | –0.5 V to 6 V  |
| Input clamp current, $I_{IK}$ ( $V_I < 0$ V or $V_I > V_{CC}$ ) (see Note 1)  | ±20 mA         |
| Output clamp current, $I_{OK}$ ( $V_O < 0$ V or $V_O > V_{CC}$ ) (see Note 1) | ±50 mA         |
| Continuous output current, $I_O$ ( $V_O > 0$ V or $V_O < V_{CC}$ )            | ±50 mA         |
| Continuous current through $V_{CC}$ or GND                                    | ±100 mA        |
| Package thermal impedance, $\theta_{JA}$ (see Note 2): E package              | 67°C/W         |
| M package   | 73°C/W         |
| Storage temperature range, $T_{stg}$  | –65°C to 150°C |

<sup>†</sup> Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.  
2. The package thermal impedance is calculated in accordance with JESD 51-7.

### recommended operating conditions (see Note 3)

|                     |                                    | $T_A = 25^\circ\text{C}$ |          | –55°C to 125°C |          | –40°C to 85°C |          | UNIT |
|---------------------|------------------------------------|--------------------------|----------|----------------|----------|---------------|----------|------|
|                     |                                    | MIN                      | MAX      | MIN            | MAX      | MIN           | MAX      |      |
| $V_{CC}$            | Supply voltage                     | 4.5                      | 5.5      | 4.5            | 5.5      | 4.5           | 5.5      | V    |
| $V_{IH}$            | High-level input voltage           | 2                        |          | 2              |          | 2             |          | V    |
| $V_{IL}$            | Low-level input voltage            |                          | 0.8      |                | 0.8      |               | 0.8      | V    |
| $V_I$               | Input voltage                      | 0                        | $V_{CC}$ | 0              | $V_{CC}$ | 0             | $V_{CC}$ | V    |
| $V_O$               | Output voltage                     | 0                        | $V_{CC}$ | 0              | $V_{CC}$ | 0             | $V_{CC}$ | V    |
| $I_{OH}$            | High-level output current          |                          | –24      |                | –24      |               | –24      | mA   |
| $I_{OL}$            | Low-level output current           |                          | 24       |                | 24       |               | 24       | mA   |
| $\Delta t/\Delta v$ | Input transition rise or fall rate |                          | 10       |                | 10       |               | 10       | ns/V |

NOTE 3: All unused inputs of the device must be held at  $V_{CC}$  or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.



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# CD54ACT109, CD74ACT109

## DUAL J-K POSITIVE-EDGE-TRIGGERED FLIP-FLOPS

### WITH CLEAR AND PRESET

SCHS327 – JANUARY 2003

**electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)**

| PARAMETER          | TEST CONDITIONS   |                           | V <sub>CC</sub> | T <sub>A</sub> = 25°C |      | –55°C to 125°C |      | –40°C to 85°C |      | UNIT |
|--------------------|---|---------------------------|-----------------|-----------------------|------|----------------|------|---------------|------|------|
|                    |   |                           |                 | MIN                   | MAX  | MIN            | MAX  | MIN           | MAX  |      |
| V <sub>OH</sub>    | V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub>         | I <sub>OH</sub> = –50 µA  | 4.5 V           | 4.4                   |      | 4.4            |      | 4.4           |      | V    |
|                    |   | I <sub>OH</sub> = –24 mA  | 4.5 V           | 3.94                  |      | 3.7            |      | 3.8           |      |      |
|                    |   | I <sub>OH</sub> = –50 mA† | 5.5 V           |                       |      | 3.85           |      |               |      |      |
|                    |   | I <sub>OH</sub> = –75 mA† | 5.5 V           |                       |      |                |      | 3.85          |      |      |
| V <sub>OL</sub>    | V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub>         | I <sub>OL</sub> = 50 µA   | 4.5 V           |                       | 0.1  |                | 0.1  |               | 0.1  | V    |
|                    |   | I <sub>OL</sub> = 24 mA   | 4.5 V           |                       | 0.36 |                | 0.5  |               | 0.44 |      |
|                    |   | I <sub>OL</sub> = 50 mA†  | 5.5 V           |                       |      |                | 1.65 |               |      |      |
|                    |   | I <sub>OL</sub> = 75 mA†  | 5.5 V           |                       |      |                |      |               | 1.65 |      |
| I <sub>I</sub>     | V <sub>I</sub> = V <sub>CC</sub> or GND                     |                           | 5.5 V           |                       | ±0.1 |                | ±1   |               | ±1   | µA   |
| I <sub>CC</sub>    | V <sub>I</sub> = V <sub>CC</sub> or GND, I <sub>O</sub> = 0 |                           | 5.5 V           |                       | 4    |                | 80   |               | 40   | µA   |
| ΔI <sub>CC</sub> ‡ | V <sub>I</sub> = V <sub>CC</sub> – 2.1 V                    |                           | 4.5 V to 5.5 V  |                       | 2.4  |                | 3    |               | 2.8  | mA   |
| C <sub>i</sub>     |   |                           |                 |                       | 10   |                | 10   |               | 10   | pF   |

† Test one output at a time, not exceeding 1-second duration. Measurement is made by forcing indicated current and measuring voltage to minimize power dissipation. Test verifies a minimum 50-Ω transmission-line drive capability at 85°C and 75-Ω transmission-line drive capability at 125°C.

‡ Additional quiescent supply current per input pin, TTL inputs high, 1 unit load

**ACT INPUT LOAD TABLE**

| INPUT      | UNIT LOAD |
|------------|-----------|
| J or CLK   | 1         |
| K          | 0.53      |
| CLR or PRE | 0.58      |

Unit Load is ΔI<sub>CC</sub> limit specified in electrical characteristics table (e.g., 2.4 mA at 25°C).

**timing requirements over recommended operating conditions (unless otherwise noted)**

|                    |                            |                 | –55°C to 125°C |     | –40°C to 85°C |     | UNIT |
|--------------------|----------------------------|-----------------|----------------|-----|---------------|-----|------|
|                    |                            |                 | MIN            | MAX | MIN           | MAX |      |
| f <sub>clock</sub> | Clock frequency            |                 |                | 100 |               | 114 | MHz  |
| t <sub>w</sub>     | Pulse duration             | CLK high or low |                | 5   |               | 4.4 | ns   |
|                    |                            | CLR or PRE low  |                | 5.5 |               | 4.8 |      |
| t <sub>su</sub>    | Setup time, before CLK↑    | J or K          |                | 5.5 |               | 4.8 | ns   |
| t <sub>h</sub>     | Hold time, after CLK↑      | J or K          |                | 0   |               | 0   | ns   |
| t <sub>rec</sub>   | Recovery time, before CLK↑ | CLR↑ or PRE↑    |                | 2.5 |               | 2.2 | ns   |



**CD54ACT109, CD74ACT109**  
**DUAL J-K POSITIVE-EDGE-TRIGGERED FLIP-FLOPS**  
**WITH CLEAR AND PRESET**

SCHS327 – JANUARY 2003

**switching characteristics over recommended operating free-air temperature range,**  
 **$V_{CC} = 5\text{ V} \pm 0.5\text{ V}$ ,  $C_L = 50\text{ pF}$  (unless otherwise noted) (see Figure 1)**

| PARAMETER  | FROM<br>(INPUT)                                    | TO<br>(OUTPUT) | –55°C to<br>125°C |      | –40°C to<br>85°C |      | UNIT |
|------------|--|----------------|-------------------|------|------------------|------|------|
|            |  |                | MIN               | MAX  | MIN              | MAX  |      |
| $f_{\max}$ |  |                | 100               |      | 114              |      | MHz  |
| $t_{PLH}$  | CLK  | Q or $\bar{Q}$ | 2.6               | 10.3 | 2.7              | 9.4  | ns   |
|            | $\overline{\text{CLR}}$ or $\overline{\text{PRE}}$ |                | 3.1               | 12.2 | 3.2              | 11.1 |      |
| $t_{PHL}$  | CLK  | Q or $\bar{Q}$ | 2.6               | 10.3 | 2.7              | 9.4  | ns   |
|            | $\overline{\text{CLR}}$ or $\overline{\text{PRE}}$ |                | 3.1               | 12.2 | 3.2              | 11.1 |      |

**operating characteristics,  $V_{CC} = 5\text{ V}$ ,  $T_A = 25^\circ\text{C}$**

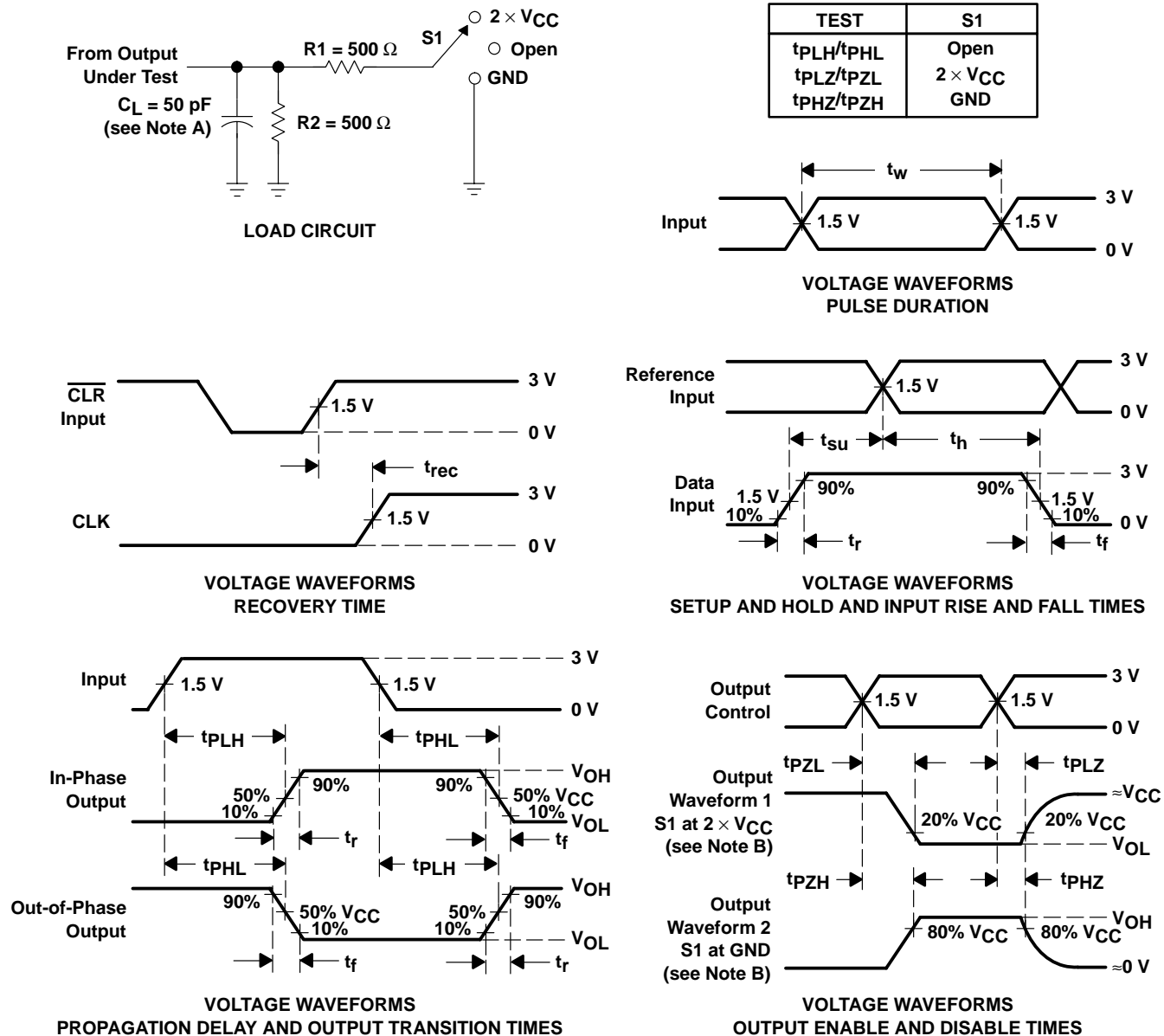
| PARAMETER |                               | TYP | UNIT |
|-----------|-------------------------------|-----|------|
| $C_{pd}$  | Power dissipation capacitance | 56  | pF   |



# CD54ACT109, CD74ACT109 DUAL J-K POSITIVE-EDGE-TRIGGERED FLIP-FLOPS WITH CLEAR AND PRESET

SCHS327 – JANUARY 2003

## PARAMETER MEASUREMENT INFORMATION



- NOTES:
- $C_L$  includes probe and test-fixture capacitance.
  - Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
  - All input pulses are supplied by generators having the following characteristics:  $PRR \leq 1 \text{ MHz}$ ,  $Z_O = 50 \Omega$ ,  $t_r = 3 \text{ ns}$ ,  $t_f = 3 \text{ ns}$ . Phase relationships between waveforms are arbitrary.
  - For clock inputs,  $f_{max}$  is measured with the input duty cycle at 50%.
  - The outputs are measured one at a time with one input transition per measurement.
  - $t_{PLH}$  and  $t_{PHL}$  are the same as  $t_{pd}$ .
  - $t_{PZL}$  and  $t_{PZH}$  are the same as  $t_{en}$ .
  - $t_{PLZ}$  and  $t_{PHZ}$  are the same as  $t_{dis}$ .
  - All parameters and waveforms are not applicable to all devices.

Figure 1. Load Circuit and Voltage Waveforms

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**PACKAGING INFORMATION**

| Orderable Device | Status <sup>(1)</sup> | Package Type | Package Drawing | Pins | Package Qty | Eco Plan <sup>(2)</sup> | Lead/Ball Finish | MSL Peak Temp <sup>(3)</sup> |
|------------------|-----------------------|--------------|-----------------|------|-------------|-------------------------|------------------|------------------------------|
| CD54ACT109F3A    | ACTIVE                | CDIP         | J               | 16   | 1           | TBD                     | A42 SNPB         | N / A for Pkg Type           |
| CD74ACT109E      | ACTIVE                | PDIP         | N               | 16   | 25          | Pb-Free (RoHS)          | CU NIPDAU        | N / A for Pkg Type           |
| CD74ACT109EE4    | ACTIVE                | PDIP         | N               | 16   | 25          | Pb-Free (RoHS)          | CU NIPDAU        | N / A for Pkg Type           |
| CD74ACT109M      | ACTIVE                | SOIC         | D               | 16   | 40          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| CD74ACT109M96    | ACTIVE                | SOIC         | D               | 16   | 2500        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| CD74ACT109M96E4  | ACTIVE                | SOIC         | D               | 16   | 2500        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| CD74ACT109M96G4  | ACTIVE                | SOIC         | D               | 16   | 2500        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| CD74ACT109ME4    | ACTIVE                | SOIC         | D               | 16   | 40          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| CD74ACT109MG4    | ACTIVE                | SOIC         | D               | 16   | 40          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |

<sup>(1)</sup> The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

<sup>(2)</sup> Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

**TBD:** The Pb-Free/Green conversion plan has not been defined.

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**Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

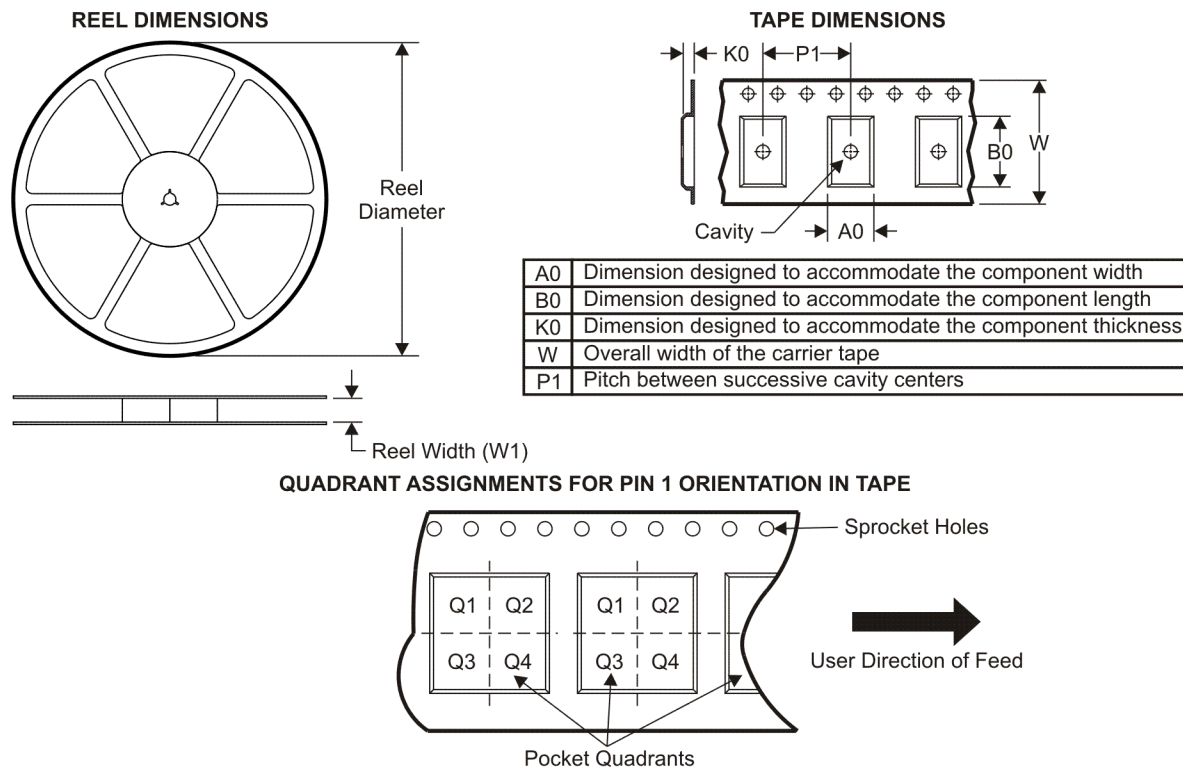
**Green (RoHS & no Sb/Br):** TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

<sup>(3)</sup> MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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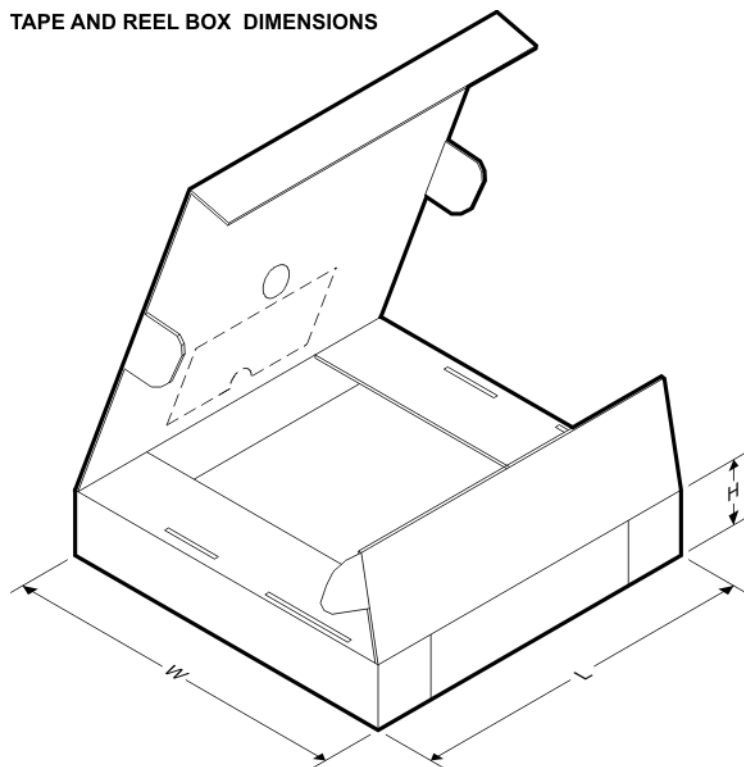
**TAPE AND REEL INFORMATION**



\*All dimensions are nominal

| Device        | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|---------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| CD74ACT109M96 | SOIC         | D               | 16   | 2500 | 330.0              | 16.4               | 6.5     | 10.3    | 2.1     | 8.0     | 16.0   | Q1            |

## TAPE AND REEL BOX DIMENSIONS



\*All dimensions are nominal

| Device        | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|---------------|--------------|-----------------|------|------|-------------|------------|-------------|
| CD74ACT109M96 | SOIC         | D               | 16   | 2500 | 333.2       | 345.9      | 28.6        |

J (R-GDIP-T\*\*)

14 LEADS SHOWN

# CERAMIC DUAL IN-LINE PACKAGE



| PINS **<br>DIM | 14                     | 16                     | 18                     | 20                     |
|----------------|------------------------|------------------------|------------------------|------------------------|
| A              | 0.300<br>(7,62)<br>BSC | 0.300<br>(7,62)<br>BSC | 0.300<br>(7,62)<br>BSC | 0.300<br>(7,62)<br>BSC |
| B MAX          | 0.785<br>(19,94)       | .840<br>(21,34)        | 0.960<br>(24,38)       | 1.060<br>(26,92)       |
| B MIN          | —                      | —                      | —                      | —                      |
| C MAX          | 0.300<br>(7,62)        | 0.300<br>(7,62)        | 0.310<br>(7,87)        | 0.300<br>(7,62)        |
| C MIN          | 0.245<br>(6,22)        | 0.245<br>(6,22)        | 0.220<br>(5,59)        | 0.245<br>(6,22)        |

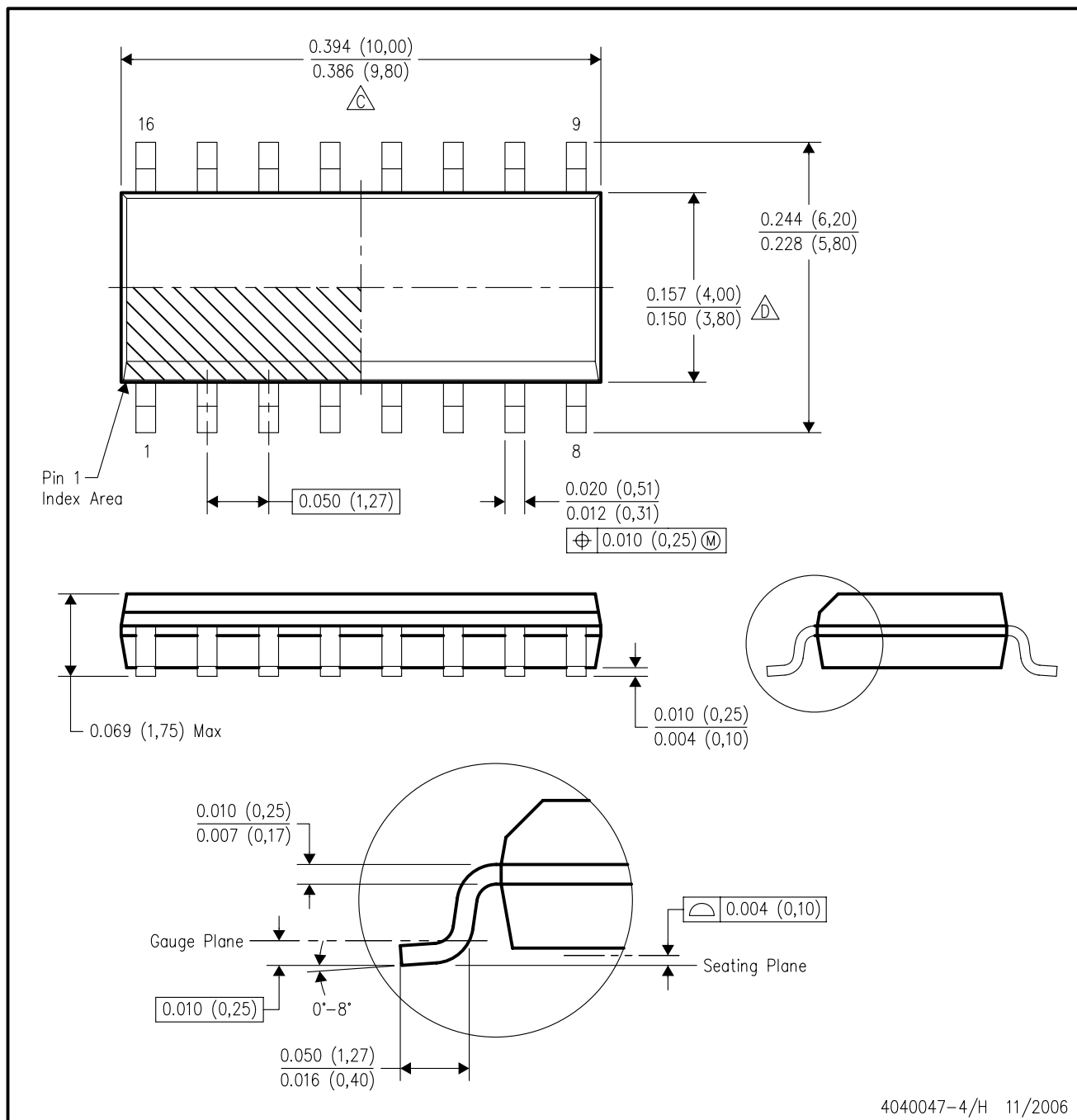


4040083/F 03/03

- NOTES:
- A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - C. This package is hermetically sealed with a ceramic lid using glass frit.
  - D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
  - E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

## D (R-PDSO-G16)

## PLASTIC SMALL-OUTLINE PACKAGE



4040047-4/H 11/2006

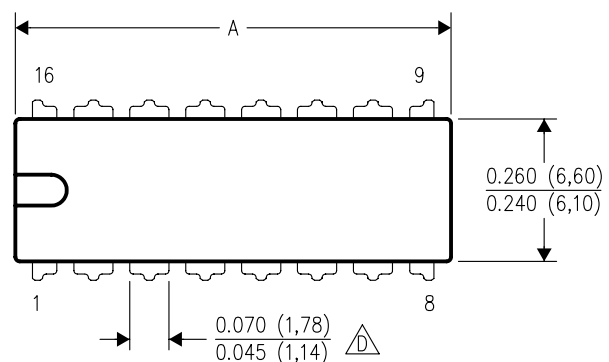
## NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed .006 (0,15) per end.
- D. Body width does not include interlead flash. Interlead flash shall not exceed .017 (0,43) per side.
- E. Reference JEDEC MS-012 variation AC.

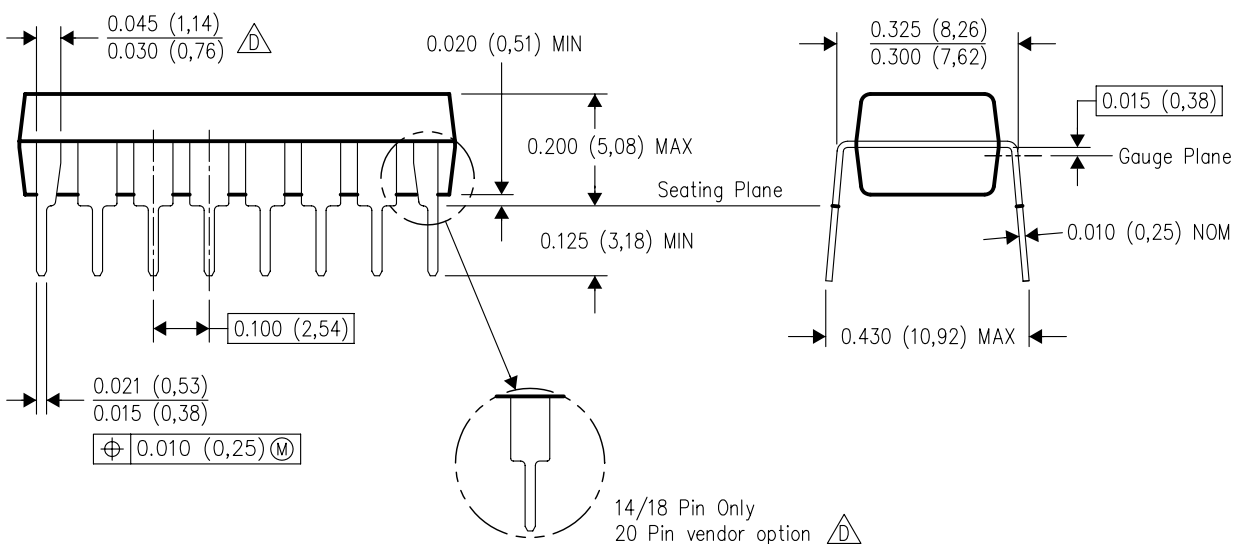
N (R-PDIP-T\*\*)

16 PINS SHOWN

## PLASTIC DUAL-IN-LINE PACKAGE





| PINS **<br>DIM      | 14               | 16               | 18               | 20               |
|---------------------|------------------|------------------|------------------|------------------|
| A MAX               | 0.775<br>(19,69) | 0.775<br>(19,69) | 0.920<br>(23,37) | 1.060<br>(26,92) |
| A MIN               | 0.745<br>(18,92) | 0.745<br>(18,92) | 0.850<br>(21,59) | 0.940<br>(23,88) |
| MS-001<br>VARIATION | AA               | BB               | AC               | AD               |



4040049/E 12/2002

NOTES:

- A. All linear dimensions are in inches (millimeters).  
B. This drawing is subject to change without notice.
-  Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).  
 The 20 pin end lead shoulder width is a vendor option, either half or full width.

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Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265  
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